ORNEY FOR PATENT APPLICATION

As a below named Inventor, I hereby declare that:

Post Office Address

DOCKET NO. <u>TS2001-450</u>

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitle

Grid Metal Design For Large Densit	y CMOS Image Sensor .	COP	
the specification of which (check one)		ORIGI	Y OF PAPERS NALLY FILED
X is attached hereto.			
was filed on			
Application Serial No.			<del></del>
and was amended on			_
(if a hereby state that I have reviewed and t amended by any amendment referred to	pplicable) inderstand the contents of the all above.	pove Identified specification including	the claims, as
acknowledge the duty to disclose infor 37, Code of Federal Regulations, §1.56	mation which is material to the (a).	examination of this application in acco	rdance with Titl
hereby claim foreign priority benefits unventor's certificate listed below and has filing date before that of the application foreign Application(s)	inder Title 35, United States Coo ave also identified below any for n on which priority is claimed:	de §119 of any foreign application(s) teign application for patent or inventor	or patent or is certificate have the proof of the proof o
		Priority Cla	TO CE
(Number)	(Country)	(Day/Month/Year Filed)	6x C
(Number)	(Country)	(Day/Month/Year Filed)	黑昌
hereby claim the benefit under Title 35 as the subject matter of each of the claim provided by the first paragraph of Title 3 defined in Title 37, Code of Federal Regnational or PCT international filing date	35, United States Code, \$112, 1:	osed in the prior United States applica acknowledge the duty to disclose mated and between the filing date of the prior	tion in the mann erial information application and
(Application Serial No.)	(Filing Date) (Status)	(patented, pending, abandoned)	
hereby declare that all statements made belief are believed to be true; and further he like so made are punishable by fine o hat such willful false statements may jec	r imprisonment or harb	e with the knowledge that willful false	n information and e statements and I States Code an
POWER OF ATTORNEY: As a named pplication and transact all business in the	o - atom and Trademark Office (	connected therewith, (list name & regi	stration no.)
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